

March 18, 2024

Reference: CSIO/2024/MSI-SSP0057/2C-1803

Subject: Quotation for the fabrication of PCB for the ongoing project activities- reg

It is informed that following items are proposed to be purchased /fabricated. Interested parties are requested to submit quotation through email/hard copy to; [head.pme@csio.res.in](mailto:head.pme@csio.res.in), [goraj@csio.res.in](mailto:goraj@csio.res.in) within 10 days from the date of publishing of notice i.e. 28.03.2024.

Items/Goods/Job work required

Sr. No.	Description of the items/Goods/Jobwork	Quantity
1	PCB Fabrication and Component Assembly as per the Annexure- I	03 Panels

Terms and Conditions:

Delivery: For CSIR-CSIO, Chandigarh

Lead time/delivery time: 4-6 weeks

Payment: As per CSIO Norms



Goraj Singh  
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HEAD ISD, with a request to display on the CSIO website.

**Annexure-1**

**Board Specifications:**

Type of PCB	With LCSO Certification
No. of layers	04
PCB Material	FR4
Copper Thickness	35 microns (1 oz)
Board Thickness	1.6 mm
Surface Thickness	HAL

Board Description	Dimensions	Quantity	Type
LL_V8_PCB	35.5mm X 13.8 mm	12 Nos.	4X1 Panel 3 Nos. to realise total quantity of 12 nos.

**Panel Size-35.5 mm X 60.77 mm**

